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RoHS

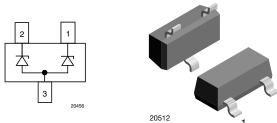
COMPLIANT

HALOGEN

FREE

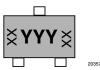
GREEN (5-2008)

Two-Line ESD Protection in SOT-23



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MARKING (example only)



YYY = type code (see table below) XX = date code

DESIGN SUPPORT TOOLS click logo to get started



• ESD immunity acc. IEC 61000-4-2 ± 30 kV contact discharge ± 30 kV air discharge

Two-line ESD protection device

- ESD capability according to AEC-Q101: human body model: class H3B: > 8 kV
- Space saving SOT-23 package
- e3 Sn

FEATURES

- AEC-Q101 qualified available
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

ORDERIN	ORDERING INFORMATION									
	ENVIR	ONMENTAL AN	ID QUALITY CO	DDE	PACKAG	ING CODE				
PART NUMBER (EXAMPLE)	AEC-Q101 QUALIFIED			3K PER 7" REEL (8 mm TAPE),	10K PER 13" REEL (8 mm TAPE),	ORDERING CODE (EXAMPLE)				
	QUALIFIED	STANDARD	GREEN	PLATED	15K/BOX = MOQ	10K/BOX = MOQ				
GSOT05C-		E		3	-08		GSOT05C-E3-08			
GSOT05C-			G	3	-08		GSOT05C-G3-08			
GSOT05C-	Н	E		3	-08		GSOT05C-HE3-08			
GSOT05C-	Н		G	3	-08		GSOT05C-HG3-08			
GSOT05C-		E		3		-18	GSOT05C-E3-18			
GSOT05C-			G	3		-18	GSOT05C-G3-18			
GSOT05C-	Н	E		3		-18	GSOT05C-HE3-18			
GSOT05C-	Н		G	3		-18	GSOT05C-HG3-18			

PACKA	GE DATA						
DEVICE NAME	PACKAGE NAME	TYPE CODE	ENVIRONMENTAL STATUS	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS
GSOT03C	SOT-23	03C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals
0001000	001 20	C1G	Green	8.1 mg	02 34 7 0	(according J-STD-020)	200 0/10 3 at terminals
GSOT04C	SOT-23	04C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals
0001040	301-23	C8G	Green	8.1 mg	02 34 0-0	(according J-STD-020)	200 O/10 S at terminals
GSOT05C	SOT-23	05C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals
6301050	301-23	C2G	Green	8.1 mg	UL 94 V-0	(according J-STD-020)	200 C/10 s at terminals
GSOT08C	SOT-23	08C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals
6301060	C SOI-23 C30		Green	8.1 mg	UL 94 V-0	(according J-STD-020)	200 C/10 s at terminais
GSOT12C	SOT-23	12C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals
6301120	301-23	C4G	Green	8.1 mg	UL 94 V-0	(according J-STD-020)	200 C/10 s at terminais
GSOT15C	SOT-23	15C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals
GSUIISC	501-23	C5G	Green	8.1 mg	UL 94 V-0	(according J-STD-020)	260 C/10 s at terminais
0007040	SOT-23	24C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 a at terminala
GSOT24C	501-23	C6G	Green	8.1 mg	UL 94 V-U	(according J-STD-020)	260 °C/10 s at terminals
GSOT36C	SOT-23	36C	Standard	8.8 mg	UL 94 V-0	MSL level 1	260 °C/10 s at terminals
6301300	301-23	C7G	Green	8.1 mg	UL 94 V-U	(according J-STD-020)	200 C/10 S at terminals

Rev. 2.6, 02-May-17

1 For technical questions, contact: ESDprotection@vishay.com Document Number: 85824

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ABSOLUTE MAXIMUM RATINGS GSOT03C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I	30	А	
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I _{PPM} 30	А		
	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	Р	369	W	
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	504	W	
	Contact discharge acc. IEC 61000-4-2; 10 pulses	N/	± 30	kV	
ESD immunity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV	
Operating temperature	Junction temperature	TJ	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	

ABSOLUTE MAXIMUM RATINGS GSOT04C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	. I	30	А		
	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM	30	А		
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	429	W		
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	ГРР	564	W		
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV		
ESD immunity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV		
Operating temperature	Junction temperature	TJ	-55 to +150	°C		
Storage temperature		T _{STG}	-55 to +150	°C		

ABSOLUTE MAXIMUM RATINGS GSOT05C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot		30	А		
	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM	30	А		
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	n	480	W		
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	612	W		
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV		
ESD immunity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV		
Operating temperature	Junction temperature	TJ	-55 to +150	°C		
Storage temperature		T _{STG}	-55 to +150	°C		



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ABSOLUTE MAXIMUM RATINGS GSOT08C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
5	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot		18	А	
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I _{PPM}	18	А	
5	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	345	W	
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	Грр	400	W	
	Contact discharge acc. IEC 61000-4-2; 10 pulses	M	± 30	kV	
ESD immunity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV	
Operating temperature	Junction temperature	TJ	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	

ABSOLUTE MAXIMU	ABSOLUTE MAXIMUM RATINGS GSOT12C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT			
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot		12	A			
	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM	12	А			
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	312	W			
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	Грр	337	W			
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV			
ESD minutility	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV			
Operating temperature	Junction temperature	TJ	-55 to +150	°C			
Storage temperature		T _{STG}	-55 to +150	°C			

ABSOLUTE MAXIMUM RATINGS GSOT15C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Dealers have seed	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	1	8	А		
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM	8	А		
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	D	345	W		
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	400	W		
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV		
ESD minutility	Air discharge acc. IEC 61000-4-2; 10 pulses	VESD	± 30	kV		
Operating temperature	Junction temperature	TJ	-55 to +150	°C		
Storage temperature		T _{STG}	-55 to +150	°C		

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ABSOLUTE MAXIMUM	ABSOLUTE MAXIMUM RATINGS GSOT24C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT			
	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	I	5	А			
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM	5	А			
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	235 240	W			
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	грр		W			
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV			
	Air discharge acc. IEC 61000-4-2; 10 pulses	VESD	± 30	kV			
Operating temperature	Junction temperature	TJ	-55 to +150	°C			
Storage temperature		T _{STG}	-55 to +150	°C			

ABSOLUTE MAXIMUM RATINGS GSOT36C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot		3.5	А		
	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	IPPM	3.5	А		
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot		248	W		
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \ \mu s$; single shot	P _{PP}	252	W		
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV		
ESD minumity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV		
Operating temperature	Junction temperature	TJ	-55 to +150	°C		
Storage temperature		T _{STG}	-55 to +150	°C		



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BIAs-MODE (2-line Bidirectional Asymmetrical protection mode)

With the GSOTxxC two signal- or data-lines (L1, L2) can be protected against voltage transients. With pin 3 connected to ground and pin 1 and pin 2 connected to a signal- or data-line which has to be protected. As long as the voltage level on the data- or signal-line is between 0 V (ground level) and the specified Maximum Reverse Working Voltage (V_{RWM}) the protection diode between pin 2 and pin 3 and between pin 1 and pin 3 offers a high isolation to the ground line. The protection device behaves like an open switch.

As soon as any positive transient voltage signal exceeds the breakdown voltage level of the protection diode, the diode becomes conductive and shorts the transient current to ground. Now the protection device behaves like a closed switch. The Clamping Voltage (V_C) is defined by the breakdown voltage (V_{BR}) level plus the voltage drop at the series impedance (resistance and inductance) of the protection diode.

Any negative transient signal will be clamped accordingly. The negative transient current is flowing in the forward direction through the protection diode. The low Forward Voltage (V_F) clamps the negative transient close to the ground level.

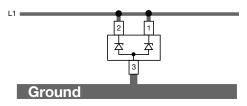
Due to the different clamping levels in forward and reverse direction the GSOTxxC clamping behavior is Bidirectional and Asymmetrical (BiAs).



If a higher surge current or peak pulse current (I_{PP}) is needed, both protection diodes in the GSOTxxC can also be used in parallel in order to "double" the performance.

This offers:

- double surge power = double peak pulse current (2 x I_{PPM})
- half of the line inductance = reduced clamping voltage
- half of the line resistance = reduced clamping voltage
- double line capacitance (2 x C_D)
- double reverse leakage current (2 x I_R)



20359

ELECTRICAL CHARACTERISTICS GSOT03C ($T_{amb} = 25$ °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines		
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	3.3	V		
Reverse voltage	at I _R = 100 μA	V _R	3.3	-	-	V		
Reverse current	at V _R = 3.3 V	I _R	-	-	100	μA		
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	4.0	4.6	5.5	V		
	at I _{PP} = 1 A	M	-	5.7	7.5	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	10	12.3	V		
	at I _{PP} = 1 A	N	-	1	1.2	V		
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F	-	4.5	-	V		
0	at $V_R = 0$ V; f = 1 MHz	0	-	420	600	pF		
Capacitance	at V _R = 1.6 V; f = 1 MHz	C _D	-	260	-	pF		

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ELECTRICAL CHARACTERISTICS GSOT04C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3							
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines	
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	4	V	
Reverse voltage	at I _R = 20 µA	V _R	4	-	-	V	
Reverse current	at V _R = 4 V	I _R	-	-	20	μA	
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	5	6.1	7	V	
Deverse elemping veltage	at I _{PP} = 1 A	V	-	7.5	9	V	
Reverse clamping voltage	at $I_{PP} = I_{PPM} = 30 \text{ A}$	V _C	-	11.2	14.3	V	
	at I _{PP} = 1 A	N	-	1	1.2	V	
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F	-	4.5	-	V	
Q	at $V_R = 0 V$; f = 1 MHz	<u> </u>	-	310	450	pF	
Capacitance	at V _R = 2 V; f = 1 MHz	C _D	-	200	-	pF	

ELECTRICAL CHARACTERISTICS GSOT05C ($T_{amb} = 25$ °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	5	V
Reverse voltage	at I _R = 10 μA	V _R	5	-	-	V
Reverse current	at V _R = 5 V	I _R	-	-	10	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	6	6.8	8	V
Reverse clamping voltage	at I _{PP} = 1 A	V	-	7	8.7	V
Reverse clamping voltage	at $I_{PP} = I_{PPM} = 30 \text{ A}$	V _C	-	12	16	V
Forward elemping veltage	at I _{PP} = 1 A	V	-	1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	30 A V _F -	-	4.5	-	V
Capacitance	at $V_R = 0$ V; f = 1 MHz	CD	-	260	350	pF
	at V _R = 2.5 V; f = 1 MHz		-	150	-	pF

between pin 1 to pin 3 or	TERISTICS GSOT08C (T _{amb} = 25 pin 2 to pin 3	C unless		specified	,	
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	8	V
Reverse voltage	at I _R = 5 μA	V _R	8	-	-	V
Reverse current	at V _R = 8 V	I _R	-	-	5	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	9	10	11	V
Deverse elemping veltage	at I _{PP} = 1 A	V	-	10.7	13	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 18 A	V _C	-	15.2	19.2	V
Forward clamping valtage	at I _{PP} = 1 A	V	-	1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 18 A	V _F	-	3	-	V
a	at $V_R = 0 V$; f = 1 MHz		-	160	250	pF
Capacitance	at V _R = 4 V; f = 1 MHz	C _D	-	80	-	pF



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ELECTRICAL CHARAC between pin 1 to pin 3 or	TERISTICS GSOT12C ($T_{amb} = 25$ pin 2 to pin 3	°C unless (otherwise	specified)	
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	12	V
Reverse voltage	at I _R = 1 µA	V _R	12	-	-	V
Reverse current	at V _R = 12 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	13.5	15	16.5	V
	at I _{PP} = 1 A	V	-	15.4	18.7	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _C	-	21.2	26	V
	at I _{PP} = 1 A	N	-	1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _F	-	2.2	-	V
0	at $V_R = 0 V$; f = 1 MHz	CD	-	115	150	pF
Capacitance	at $V_R = 6 V$; f = 1 MHz		-	50	-	pF

ELECTRICAL CHARACTERISTICS GSOT15C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3									
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines			
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	15	V			
Reverse voltage	at I _R = 1 μA	V _R	15	-	-	V			
Reverse current	at V _R = 15 V	I _R	-	-	1	μA			
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	16.5	18	20	V			
	at I _{PP} = 1 A	V	-	19.4	23.5	V			
Reverse clamping voltage	at I _{PP} = I _{PPM} = 8 A	V _C	-	24.8	28.8	V			
Forward elemening voltage	at I _{PP} = 1 A	V	-	1	1.2	V			
Forward clamping voltage	at I _{PP} = I _{PPM} = 8 A	V _F	-	1.8	-	V			
Canacitanaa	at $V_R = 0$ V; f = 1 MHz		-	90	120	pF			
Capacitance	at V _R = 7.5 V; f = 1 MHz	C _D	-	35	-	pF			

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	24	V
Reverse voltage	at I _R = 1 μA	V _R	24	-	-	V
Reverse current	at V _R = 24 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	27	30	33	V
	at I _{PP} = 1 A	V	-	34	41	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 5 A	V _C	-	41	47	V
Forward clamping valtage	at I _{PP} = 1 A	V	-	1	1.2	V
Forward clamping voltage	at I _{PP} = I _{PPM} = 5 A	V _F	-	1.4	-	V
Capacitance	at V _R = 0 V; f = 1 MHz	0	-	65	80	pF
	at $V_B = 12$ V; f = 1 MHz	CD	-	20	-	pF

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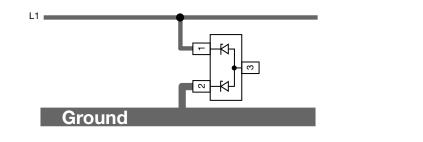
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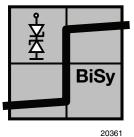
ELECTRICAL CHARAC between pin 1 to pin 3 or	TERISTICS GSOT36C (T _{amb} = 25 pin 2 to pin 3	°C unless o	otherwise	specified)	
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	36	V
Reverse voltage	at I _R = 1 μA	V _R	36	-	-	V
Reverse current	at V _R = 36 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	39	43	47	V
	at I _{PP} = 1 A	V	-	49	60	V
Reverse clamping voltage	at $I_{PP} = I_{PPM} = 3.5 \text{ A}$	V _C	-	59	71	V
	at I _{PP} = 1 A	V	-	1	1.2	V
Forward clamping voltage	at $I_{PP} = I_{PPM} = 3.5 \text{ A}$	V _F	-	1.3	-	V
Consoltance	at $V_R = 0 V$; f = 1 MHz	- C _D	-	52	65	pF
Capacitance	at V _R = 18 V; f = 1 MHz		-	12	-	pF

BiSy-MODE (1-line bidirectional symmetrical protection mode)

If a bipolar symmetrical protection device is needed the GSOTxxC can also be used as a single line protection device. Therefore pin 1 has to be connected to the signal- or data-line (L1) and pin 2 to ground (or vice versa). Pin 3 must not be connected. Positive and negative voltage transients will be clamped in the same way. The clamping current through the GSOTxxC passes one diode in forward direction and the other one in reverse direction. The clamping voltage (V_C) is defined by the breakthrough voltage (V_{BR}) level of one diode plus the forward voltage of the other diode plus the voltage drop at the series impedances (resistances and inductances) of the protection device.

Due to the same clamping levels in positive and negative direction the GSOTxxC voltage clamping behaviour is bidirectional and symmetrical (BiSy).





ELECTRICAL CHARACTERISTICS GSOT03C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected									
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines			
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	3.8	V			
Reverse voltage	at I _R = 100 μA	V _R	3.8	-	-	V			
Reverse current	at V _R = 3.8 V	I _R	-	-	100	μA			
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	4.5	5.3	6.2	V			
Poverse elemping veltage	at I _{PP} = 1 A	V	-	7	8.4	V			
Reverse clamping voltage	at $I_{PP} = I_{PPM} = 30 \text{ A}$	V _C	-	14	16.8	V			
	at $V_R = 0 V$; f = 1 MHz	0	-	210	300	pF			
Capacitance	at $V_{\rm R}$ = 1.6 V; f = 1 MHz	-	190	-	pF				

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	TERISTICS GSOT04C ($T_{amb} = 25$ pin 2 to pin1; pin 3 not connected	°C unless	otherwise	specified)	
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	4.5	V
Reverse voltage	at I _R = 20 μA	V _R	4.5	-	-	V
Reverse current	at V _R = 4.5 V	I _R	-	-	20	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	5.5	6.8	7.7	V
	at I _{PP} = 1 A	V	-	7.5	9	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	15.7	18.8	V
Capacitance	at $V_R = 0$ V; f = 1 MHz	- C _D	-	155	225	pF
	at $V_R = 2 V$; f = 1 MHz		-	135	-	pF

ELECTRICAL CHARACTERISTICS GSOT05C ($T_{amb} = 25$ °C unless otherwise specified)

between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected									
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines			
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	5.5	V			
Reverse voltage	at I _R = 10 μA	V _R	5.5	-	-	V			
Reverse current	at V _R = 5.5 V	I _R	-	-	10	μA			
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	6.5	7.5	8.7	V			
Boverse elemping veltage	at I _{PP} = 1 A	V	-	8.1	9.7	V			
Reverse clamping voltage	at $I_{PP} = I_{PPM} = 30 \text{ A}$	V _C	-	17	20.4	V			
Capacitance	at $V_R = 0 V$; f = 1 MHz	- C _D	-	130	175	pF			
	at $V_R = 4 V$; f = 1 MHz		-	100	-	pF			

ELECTRICAL CHARACTERISTICS GSOT08C ($T_{amb} = 25$ °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	8.5	V
Reverse voltage	at I _R = 5 μA	V _R	8.5	-	-	V
Reverse current	at V _R = 8.5 V	I _R	-	-	5	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	9.5	10.7	11.7	V
Poverse elemping veltage	at I _{PP} = 1 A	V	-	11.7	14	V
Reverse clamping voltage	at $I_{PP} = I_{PPM} = 18 \text{ A}$	V _C	-	18.5	22.2	V
Canacitanaa	at V _R = 0 V; f = 1 MHz	6	-	80	125	pF
Capacitance	at $V_R = 4 V$; f = 1 MHz	C _D	-	60	-	pF

ELECTRICAL CHARACTERISTICS GSOT12C ($T_{amb} = 25$ °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	12.5	V
Reverse voltage	at I _R = 1 µA	V _R	12.5	-	-	V
Reverse current	at V _R = 12.5 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	13.5	15.7	16.5	V
Deverse elemeira veltere	at I _{PP} = 1 A	M	-	16.4	19.7	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _C	-	23.4	28.1	V
0	at $V_R = 0 V$; f = 1 MHz		-	58	75	pF
Capacitance	at V _R = 7.5 V; f = 1 MHz	UD	-	36	-	pF

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	TERISTICS GSOT15C ($T_{amb} = 25$ pin 2 to pin1; pin 3 not connected	°C unless	otherwise	specified)	
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	15.5	V
Reverse voltage	at I _R = 1 μA	V _R	15.5	-	-	V
Reverse current	at V _R = 15.5 V	I _R	-	-	1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	17	18.7	20.7	V
Poweres elemping veltage	at I _{PP} = 1 A	V	-	20.4	24.5	V
Reverse clamping voltage	at I _{PP} = I _{PPM} = 8 A	V _C	-	26.6	30.6	V
Capacitance	at $V_R = 0 V$; f = 1 MHz	C _D	-	45	60	pF
	at V _R = 7.5 V; f = 1 MHz		-	25	-	pF

ELECTRICAL CHARACTERISTICS GSOT24C (T_{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected

PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines		
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	24.5	V		
Reverse voltage	at I _R = 1 μA	V _R	24.5	-	-	V		
Reverse current	at V _R = 24.5 V	I _R	-	-	1	μA		
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	27.5	30.7	33.7	V		
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	34	41	V		
	at $I_{PP} = I_{PPM} = 5 A$		-	40	48	V		
Capacitance	at $V_R = 0 V$; f = 1 MHz	- C _D	-	33	40	pF		
	at V _R = 12 V; f = 1 MHz		-	18	-	pF		

ELECTRICAL CHARACTERISTICS GSOT36C (T_{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected

between pin 1 to pin 2 to pin 2 to pin 6 hot connected									
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Protection paths	Number of lines which can be protected	Nchannel	-	-	1	lines			
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	36.5	V			
Reverse voltage	at I _R = 1 μA	V _R	36.5	-	-	V			
Reverse current	at V _R = 36.5 V	I _R	-	-	1	μA			
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	39.5	43.7	47.7	V			
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	50	60	V			
	at $I_{PP} = I_{PPM} = 3.5 \text{ A}$		-	60	72	V			
Capacitance	at $V_R = 0 V$; f = 1 MHz	- C _D	-	26	33	pF			
	at V _R = 18 V; f = 1 MHz		-	10	-	pF			

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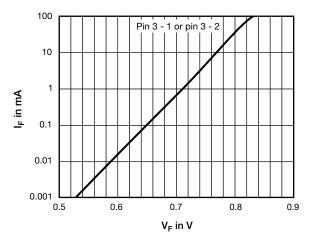


Fig. 1 - Typical Forward Current I_F vs. Forward Voltage V_F

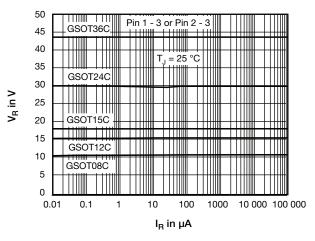


Fig. 2 - Typical Reverse Voltage V_R vs. Reverse Current I_R

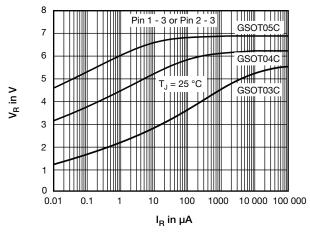


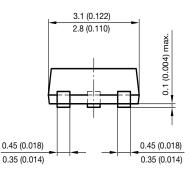
Fig. 3 - Typical Reverse Voltage V_R vs. Reverse Current I_R

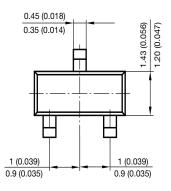
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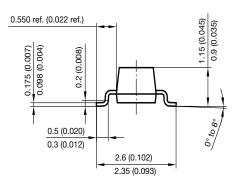


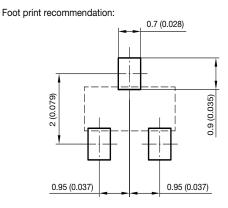
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PACKAGE DIMENSIONS in millimeters (inches): SOT-23

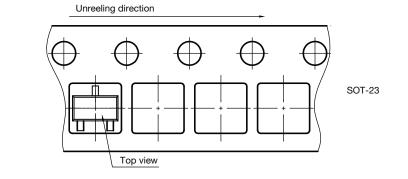








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Orientation in carrier tape SOT-23 S8-V-3929.01-006 (4) 04.02.2010 22607



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